

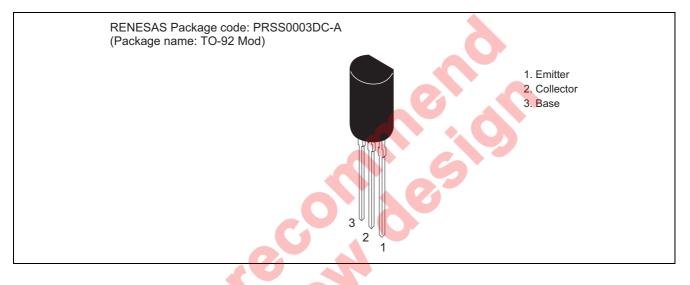
2SC1921 Silicon NPN Triple Diffused

REJ03G0695-0200 (Previous ADE-208-1060) Rev.2.00 Aug.10.2005

Application

- High frequency high voltage amplifier
- Video output

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	250	V
Collector to emitter voltage	V _{CEO}	200	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	Ι _C	50	mA
Collector power dissipation	Pc	600	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

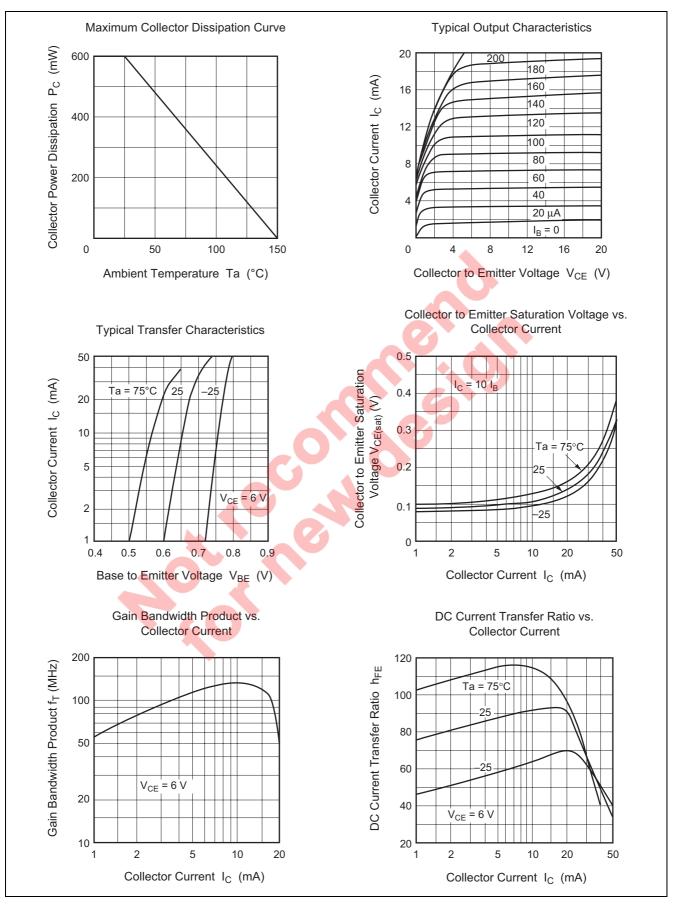


Electrical Characteristics

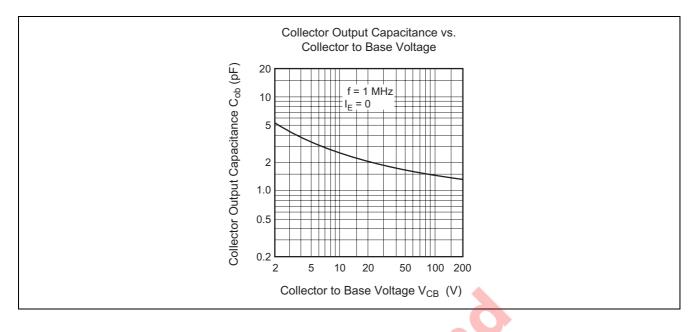
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	250	_		V	$I_{C} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	200			V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	5	_		V	$I_E = 10 \ \mu A, \ I_C = 0$
Collector cutoff current	I _{CEO}	_	_	1.0	μΑ	V_{CE} = 120 V, R_{BE} = ∞
DC current transfer ratio	h _{FE}	30	_	300		$V_{CE} = 6 V, I_C = 10 mA$
Collector to emitter saturation voltage	V _{CE(sat)}	_	_	1.0	V	$I_{C} = 10 \text{ mA}, I_{B} = 1 \text{ mA}$
Gain bandwidth product	f⊤	60	130	_	MHz	$V_{CE} = 6 \text{ V}, I_{C} = 10 \text{ mA}$
Collector output capacitance	Cob		3	4	pF	$V_{CB} = 6 V, I_E = 0, f = 1 MHz$



Main Characteristics

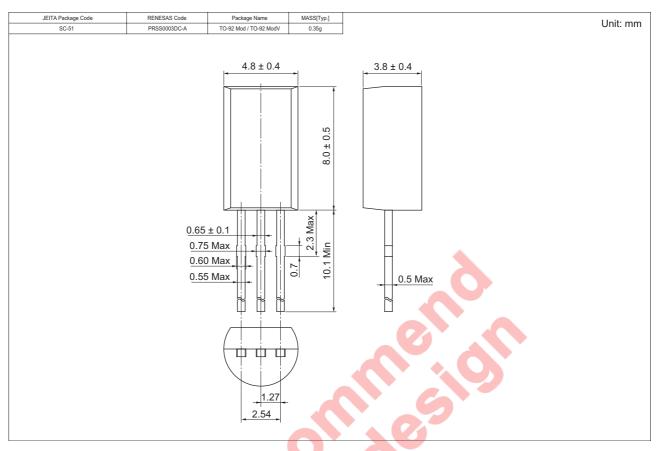








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC1921TZ-E	2500	Hold Box, Radial Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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